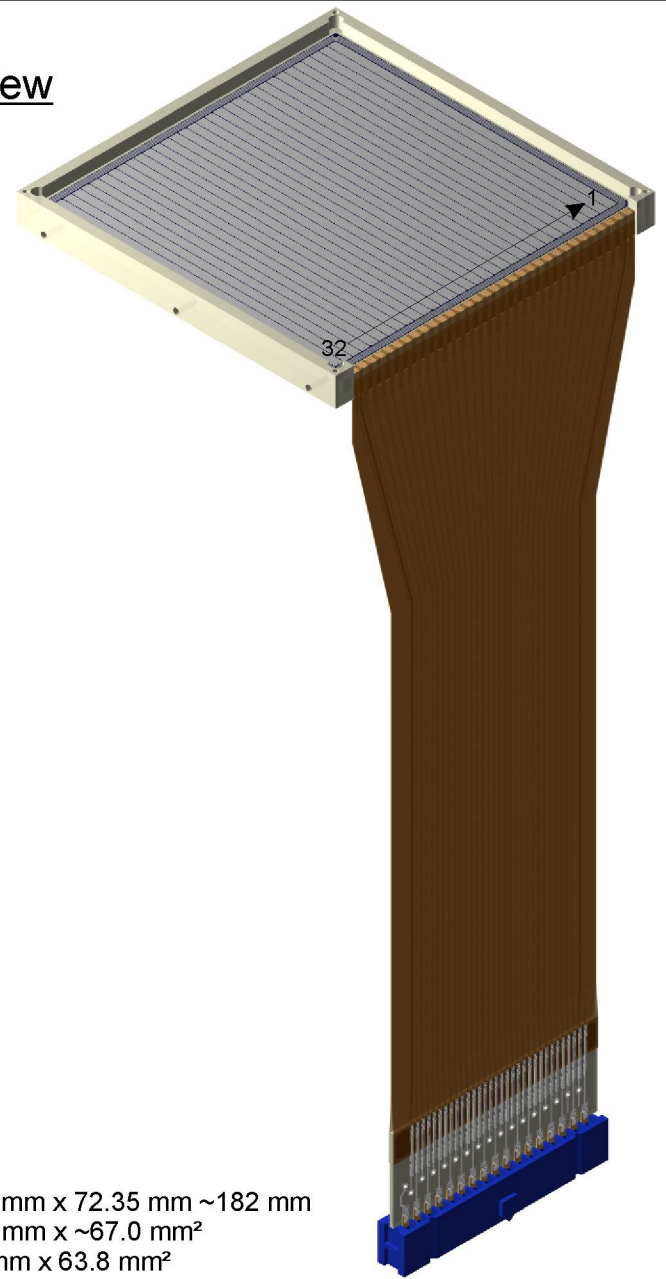
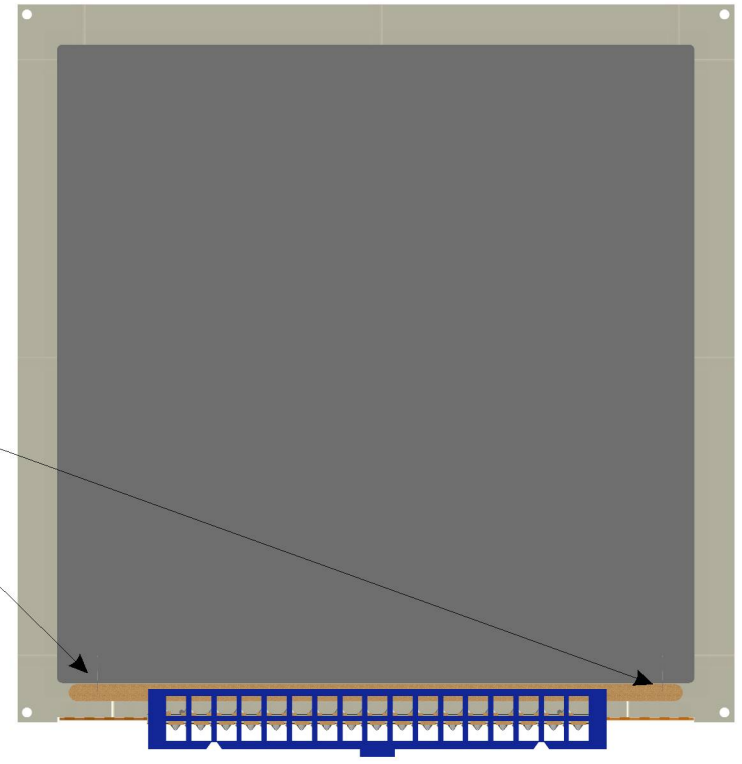


Front View

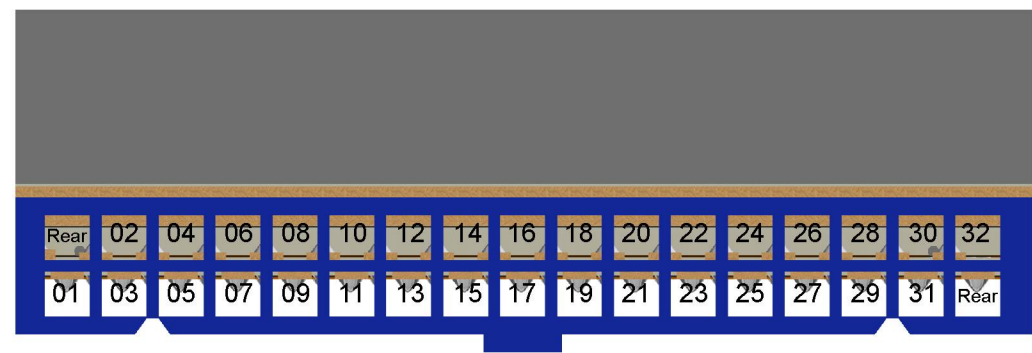


Rear View



Rear connection made by Silver wires

Connector View



PCB Dimensions = 72.35 mm x 72.35 mm ~182 mm
 Chip Dimensions = ~67.0 mm x ~67.0 mm²
 Active Area = 63.8 mm x 63.8 mm²

Rev 2 - Numbering system modified.

Drawn	Checked	Date	Tolerances Unless Stated	Outputs Via: Unknown customer supplied 2.54 x 2.54 mm connector
N.W	S.W	30/11/2012	Package O/D ± 0.1 mm	Mating connector: N/A
Des.			Package Hole ± 0.05 mm	Potted Wire Bonds: No
Appd.			Package Hole Pos'n ± 0.1 mm	Substrate Number: N/A customer supplied package
			Detector O/D ± 20.0 μm	Substrate Material: N/A customer supplied package
				Connector Orientation: connector mounted both sides of kapton rigidiser

Title.
BB7(S/S) 2M/2M
 in Customer Supplied Package.
 3D Assembly.
 Revision 2



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